



## Material Content Data Sheet



<b>Sales Product Name</b>	TLE6251-2G			<b>Issued</b>	2. August 2018			
<b>MA#</b>	MA000977738							
<b>Package</b>	PG-DSO-14-1			<b>Weight*</b>	143.60 mg			
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	5.050	3.52	3.52	35166	35166
leadframe	inorganic material	phosphorus	7723-14-0	0.015	0.01		105	
	non noble metal	zinc	7440-66-6	0.060	0.04		420	
	non noble metal	iron	7439-89-6	1.207	0.84		8405	
wire	non noble metal	copper	7440-50-8	49.007	34.13	35.02	341272	350202
	noble metal	gold	7440-57-5	0.206	0.14	0.14	1436	1436
	encapsulation	organic material	carbon black	1333-86-4	0.168	0.12		1168
encapsulation	plastics	epoxy resin	-	7.717	5.37		53741	
	inorganic material	silicondioxide	60676-86-0	75.999	52.93	58.42	529236	584145
leadfinish	non noble metal	tin	7440-31-5	1.226	0.85	0.85	8539	8539
plating	noble metal	silver	7440-22-4	1.030	0.72	0.72	7171	7171
glue	plastics	acrylic resin	-	0.421	0.29		2935	
	noble metal	silver	7440-22-4	1.494	1.04	1.33	10406	13341
*deviation	< 10%			Sum in total:		100.00		1000000

### Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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